

## SEMF05AC SERIES

### 5-Line Transient Voltage Suppressor Array

Revision:B

**General Description**

The Standard TVS are designed to low voltage, integrated circuits from transients caused by electrostatic discharge (ESD), electrical fast transients (EFT) and other induced voltages.

**Applications**

- Computer Notebooks
- Communication Systems & Cellular Phones
- Printers
- Personal Digital Assistant(PDA)
- Video Equipment

**Features**

- 100 W Peak Pulse Power per Line ( $t_p=8/20\mu s$ )
- Monolithic Structure
- Low Clamping Voltage
- ESD Protection > 40 kilovolts
- Low Leakage Current
- Protects up to Four (4) Bidirectional Lines and Five(5) Unidirectional Lines
- RoHS Compliant on Lead-Free Versions

**Complies with the following standards**

IEC61000-4-2

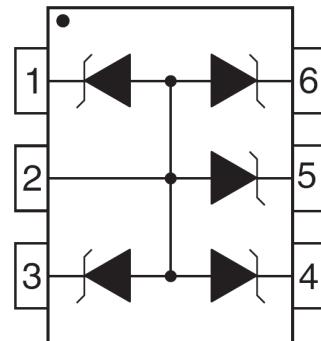
Level 4 15 kV (air discharge)  
8 kV(contact discharge)

MIL STD 883E - Method 3015-7 Class 3

25 kV HBM (Human Body Model)

**Functional Diagram**

SOT-363

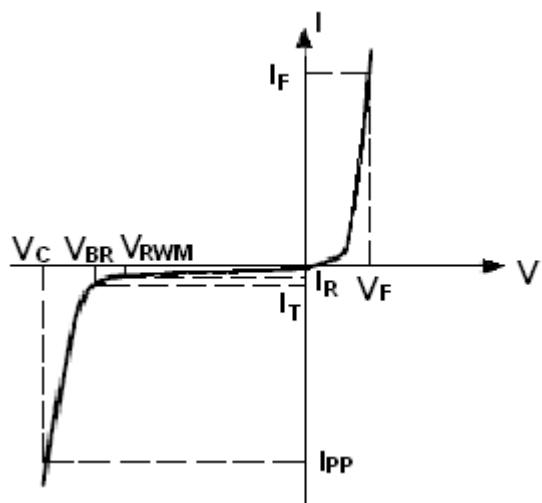
**Absolute Ratings @ 25°C Unless Otherwise Specified**

Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power ( $t_p=8/20\mu s$ ) See Figure 1	100	Watts
T <sub>J</sub>	Operating Temperature	-55°C to 150 °C	°C
T <sub>STG</sub>	Storage Temperature	-55°C to 150°C	°C

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## Electrical Parameter

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$I_T$	Test Current
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$



## Electrical Characteristics

Part Numbers	$V_{BR}$			$I_T$	$V_{RWM}$	$I_R$	C
	Min.	Typ.	Max.				Typ. 0v bias
	V	V	V				mA
SEMF05AC	6.1	6.7	7.2	1	5.0	5	35

## Typical Characteristics

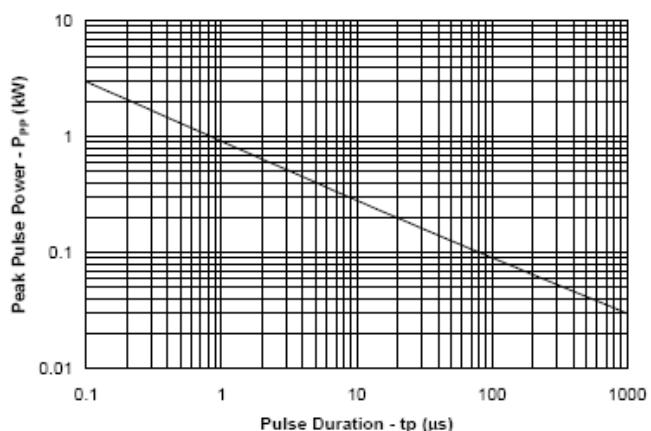


Fig1. Non-Repetitive Peak Pulse Power vs. Pulse Time

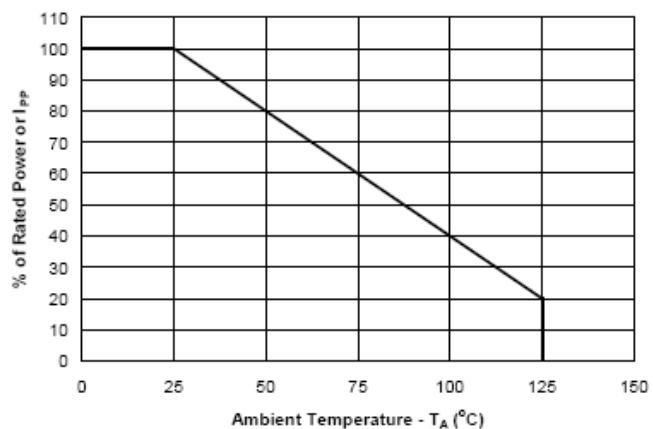
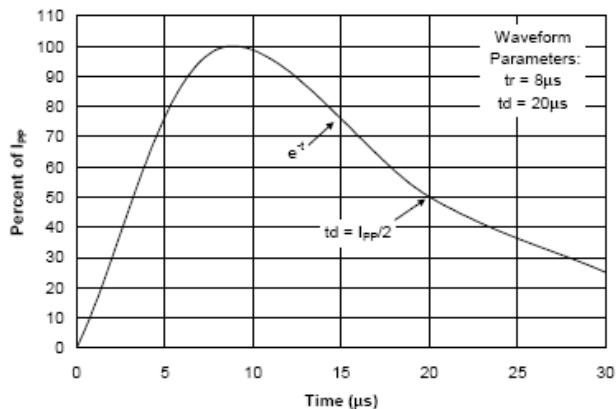
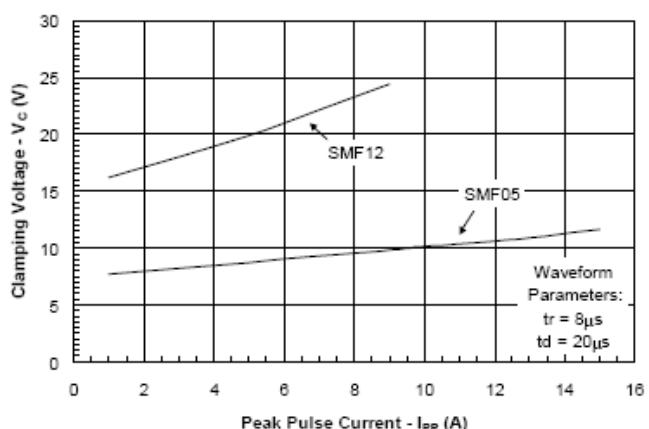


Fig2. Power Derating Curve

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**Fig3. Pulse Waveform**



**Fig4. Clamping Voltage vs. Peak Pulse Current**

## SOT-363 Mechanical Data

The diagram shows the physical dimensions of the SOT-363 package. Top view dimensions include width  $E$ , height  $b$ , lead thickness  $e$ , and lead spacing  $c$ . Side view dimensions include height  $D$ , lead pitch  $A$ , lead thickness  $e$ , lead spacing  $b$ , lead length  $L$ , and lead height  $H$ . A cross-sectional view shows lead profile and lead-to-case gap  $Q1$ . Callouts provide detailed values for each dimension.

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.8	1.1	0.031	0.043
A1	0	0.1	0	0.004
A2	0.8	1	0.031	0.039
b	0.15	0.3	0.006	0.012
c	0.1	0.18	0.004	0.007
D	1.8	2.2	0.071	0.086
E	1.15	1.35	0.045	0.053
e	0.65 Typ.		0.025 Typ.	
H	1.8	2.4	0.071	0.094
Q	0.1	0.4	0.004	0.016

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